## FAIRCHILD

SEMICロNDபロTロR®
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## FDP100N10

N－Channel PowerTrench ${ }^{\circledR}$ MOSFET
100 V， 75 A， 10 m $\Omega$

## Features

－ $\mathrm{R}_{\mathrm{DS}(\text { on })}=8.2 \mathrm{~m} \Omega$（Typ．）＠ $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=75 \mathrm{~A}$
－Fast Switching Speed
－Low Gate Charge
－High Performance Trench Technology for Extremely Low $\mathrm{R}_{\mathrm{DS}(o n)}$
－High Power and Current Handling Capability
－RoHS Compliant

## Description

This N－Channel MOSFET is produced using Fairchild Semicon－ ductor＇s advanced PowerTrench ${ }^{\circledR}$ process that has been tai－ lored to minimize the on－state resistance while maintaining superior switching performance．

## Applications

－Synchronous Rectification for ATX／Server／Telecom PSU
－Battery Protection Circuit
－Motor Drives and Uninterruptible Power Supplies
－Micor Solar Inverter


MOSFET Maximum Ratings $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted．

| Symbol |  | Parameter | FDP100N10 | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSS }}$ | Drain to Source Voltage |  | 100 | V |
| $\mathrm{V}_{\text {GSS }}$ | Gate to Source Voltage |  | $\pm 20$ | V |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current | －Continuous（ $\mathrm{T}_{\mathrm{C}}=75^{\circ} \mathrm{C}$ ） | 75 | A |
| $\mathrm{I}_{\text {DM }}$ | Drain Current | －Pulsed（Note 1） | 300 | A |
| $\mathrm{E}_{\text {AS }}$ | Single Pulsed Avalanche Energy（Note 2） |  | 365 | mJ |
| dv／dt | Peak Diode Recovery dv／dt（Note 3） |  | 6 | V／ns |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation | （ $\left.\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ | 208 | W |
|  |  | －Derate Above $25^{\circ} \mathrm{C}$ | 1.4 | W／${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J},}, \mathrm{T}_{\text {STG }}$ | Operating and Storage Temperature Range |  | －55 to＋175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum Lead Temperature for Soldering，1／8＂from Case for 5 Seconds |  | 300 | ${ }^{\circ} \mathrm{C}$ |

## Thermal Characteristics

| Symbol | Parameter | FDP100N10 | Unit |
| :--- | :--- | :---: | :---: |
| $R_{\theta J C}$ | Thermal Resistance，Junction to Case，Max． | 0.72 |  |
| $\mathrm{R}_{\theta J A}$ | Thermal Resistance，Junction to Ambient，Max． | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |

## Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FDP100N10 | FDP100N10 | TO-220 | Tube | N/A | N/A | 50 units |

Electrical Characteristics $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Off Characteristics |  |  |  |  |  |  |
| BV ${ }_{\text {DSS }}$ | Drain to Source Breakdown Voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}$ | 100 | - | - | V |
| $\begin{gathered} \Delta \mathrm{BV}_{\mathrm{DSS}} \\ / \Delta \mathrm{T}_{\mathrm{J}} \end{gathered}$ | Breakdown Voltage Temperature Coefficient | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$, Referenced to $25^{\circ} \mathrm{C}$ | - | 0.1 | - | V/ ${ }^{\circ} \mathrm{C}$ |
| ${ }^{\text {dSs }}$ | Zero Gate Voltage Drain Current | $\mathrm{V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{~V}_{G S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C}$ | - | - | 500 |  |
| IGss | Gate to Body Leakage Current | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ | - | - | $\pm 100$ | nA |

## On Characteristics

| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 2.5 | - | 4.5 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}$ | Static Drain to Source On Resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=75 \mathrm{~A}$ | - | 8.2 | 10 | $\mathrm{~m} \Omega$ |
| $\mathrm{~g}_{\mathrm{FS}}$ | Forward Transconductance | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=37.5 \mathrm{~A}$ | - | 110 | - | S |

Dynamic Characteristics

| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\begin{aligned} & V_{D S}=25 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |  | - | 5500 | 7300 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  |  | - | 530 | 710 | pF |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  |  | - | 220 | 325 | pF |
| $\mathrm{Q}_{\mathrm{g} \text { (tot) }}$ | Total Gate Charge at 10V | $\mathrm{V}_{G S}=10 \mathrm{~V}$ (Note 4) |  | - | 76 | 100 | nC |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate to Source Gate Charge |  |  | - | 30 | - | nC |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate to Drain "Miller" Charge |  |  | - | 20 | - | nC |

## Switching Characteristics

| $\mathrm{t}_{\mathrm{d} \text { (on) }}$ | Turn-On Delay Time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=75 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=25 \Omega \end{aligned}$ | (Note 4) | - | 70 | 150 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}}$ | Turn-On Rise Time |  |  | - | 265 | 540 | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay Time |  |  | - | 125 | 260 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Turn-Off Fall Time |  |  | - | 115 | 240 | ns |

## Drain-Source Diode Characteristics

| $\mathrm{I}_{\mathrm{S}}$ | Maximum Continuous Drain to Source Diode Forward Current | - | - | 75 | A |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{SM}}$ | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 300 | A |
| $\mathrm{~V}_{\mathrm{SD}}$ | Drain to Source Diode Forward Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=75 \mathrm{~A}$ | - | - | 1.25 |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=75 \mathrm{~A}$, | V |  |  |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse Recovery Charge | $\mathrm{dI}_{\mathrm{F}} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ | - | 71 | - |
| n |  | - | 164 | - | nc |

## Notes

1: Repetitive rating: pulse-width limited by maximum junction temperature.
2: $\mathrm{L}=0.13 \mathrm{mH}, \mathrm{I}_{\mathrm{AS}}=75 \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=25 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=25 \Omega$, starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
3: $\mathrm{I}_{\mathrm{SD}} \leq 75 \mathrm{~A}, \mathrm{di} / \mathrm{dt} \leq 200 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{DD}} \leq \mathrm{BV}_{\mathrm{DSS}}$, starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$.
4: Essentially independent of operating temperature typical characteristics

## Typical Performance Characteristics

Figure 1. On-Region Characteristics


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage


Figure 5. Capacitance Characteristics


Figure 2. Transfer Characteristics


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature


Figure 6. Gate Charge Characteristics


## Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature


Figure 9. Maximum Safe Operating Area


Figure 8. On-Resistance Variation vs. Temperature


Figure 10. Maximum Drain Current vs. Case Temperature


Figure 11. Transient Thermal Response Curve



Figure 12. Gate Charge Test Circuit \& Waveform


Figure 13. Resistive Switching Test Circuit \& Waveforms


Figure 14. Unclamped Inductive Switching Test Circuit \& Waveforms


## Mechanical Dimensions



Figure 16. TO-220, Molded, 3-Lead, Jedec Variation AB
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